RoHS Compliance, Silicon MOSFET Power Transistor 520MHz,1W

### **DESCRIPTION**

RD01MUS1 is a MOS FET type transistor specifically designed for VHF/UHF RF amplifiers applications.

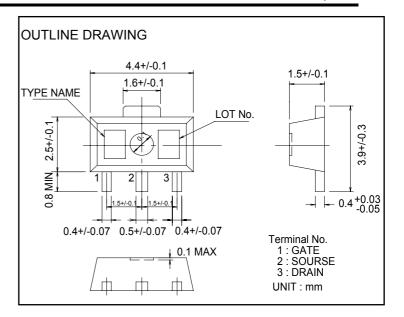
#### **FEATURES**

High power gain:

Pout>0.8W, Gp>14dB @Vdd=7.2V,f=520MHz High Efficiency: 65%typ.

#### **APPLICATION**

For output stage of high power amplifiers in VHF/UHF Band mobile radio sets.



#### **ROHS COMPLIANT**

RD01MUS1-101,T113 is a RoHS compliant products.

This product include the lead in high melting temperature type solders.

How ever, it applicable to the following exceptions of RoHS Directions.

1.Lead in high melting temperature type solders(i.e.tin-lead solder alloys containing more than 85% lead.)

### **ABSOLUTE MAXIMUM RATINGS**

(Tc=25°C UNLESS OTHERWISE NOTED)

| SYMBOL  | PARAMETER               | CONDITIONS       | RATINGS     | UNIT |
|---------|-------------------------|------------------|-------------|------|
| VDSS    | Drain to source voltage | Vgs=0V           | 30          | V    |
| VGSS    | Gate to source voltage  | Vds=0V           | +/-10       | V    |
| Pch     | Channel dissipation     | Tc=25°C          | 3.6         | W    |
| Pin     | Input Power             | Zg=Zl=50Ω        | 100         | mW   |
| ID      | Drain Current           | -                | 600         | mA   |
| Tch     | Channel Temperature     | -                | 150         | °C   |
| Tstg    | Storage temperature     | -                | -40 to +125 | °C   |
| Rth j-c | Thermal resistance      | Junction to case | 34.5        | °C/W |

Note: Above parameters are guaranteed independently.

#### **ELECTRICAL CHARACTERISTICS**

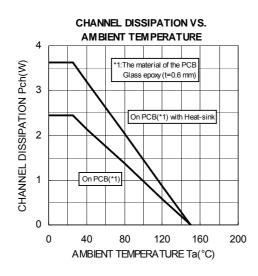
(Tc=25°C, UNLESS OTHERWISE NOTED)

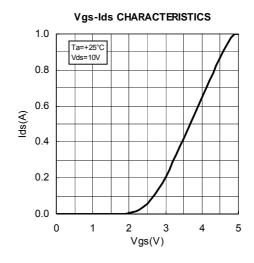
| SYMBOL PARAMETER |                                 | CONDITIONS                                 | LIMITS |     |     | UNIT |
|------------------|---------------------------------|--|--------|-----|-----|------|
|                  |                                 | CONDITIONS                                 | MIN    | TYP | MAX |      |
| IDSS             | Zero gate voltage drain current | V <sub>DS</sub> =17V, V <sub>GS</sub> =0V  | -      | -   | 50  | uA   |
| Igss             | Gate to source leak current     | Vgs=10V, VDS=0V                            | -      | -   | 1   | uA   |
| Vth              | Gate threshold Voltage          | V <sub>DS</sub> =12V, I <sub>DS</sub> =1mA | 1.3    | 1.8 | 2.3 | V    |
| Pout             | Output power                    | V <sub>DD</sub> =7.2V, Pin=30mW            | 0.8    | 1.4 | -   | W    |
| ηD               | Drain efficiency                | f=520MHz,Idq=100mA                         | 50     | 65  | -   | %    |

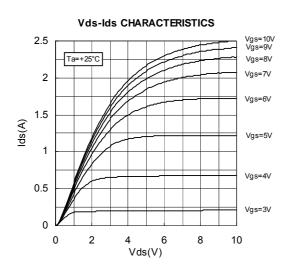
Note: Above parameters, ratings, limits and conditions are subject to change.

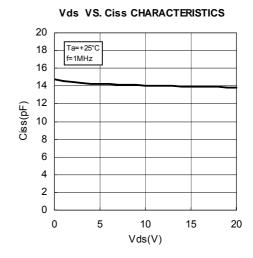
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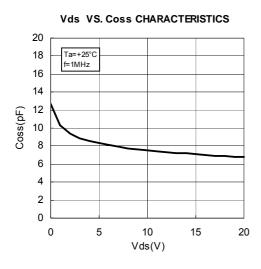
### **TYPICAL CHARACTERISTICS**

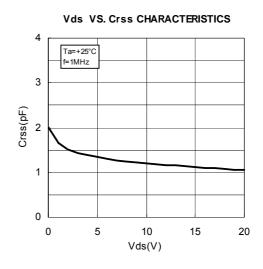






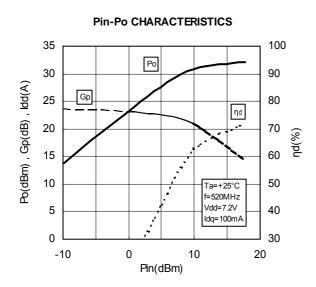


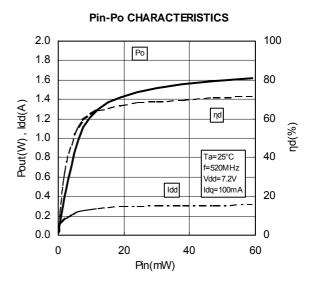




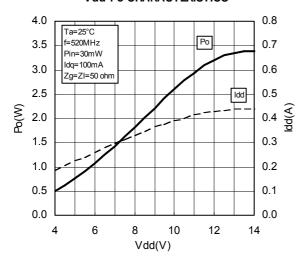
RoHS Compliance, Silicon MOSFET Power Transistor 520MHz,1W

### **TYPICAL CHARACTERISTICS**



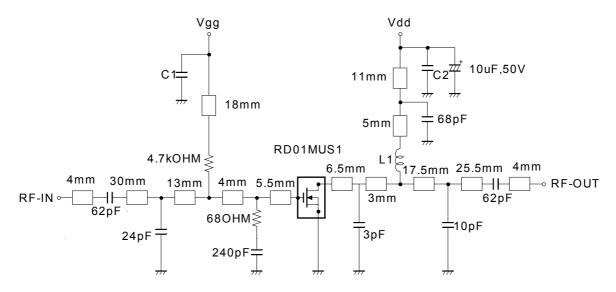


#### **Vdd-Po CHARACTERISTICS**



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## **TEST CIRCUIT(f=520MHz)**



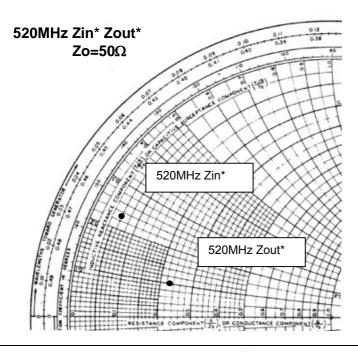
L1: Enameled wire 5Turns,D:0.43mm,2.46mmO.D

C1,C2: 1000pF,0.022uF in parallel

Note:Board material-glass epoxi substrate

Micro strip line width=1.0mm/50OHM,er:4.8,t=0.6mm

### INPUT/OUTPUT IMPEDANCE VS. FREQUENCY CHARACTERISTICS



Vdd=7.2V, Idq=100mA(Vgg adj.),Pin=0.03W

Zin\* =3.11+j11.56 Zout\*=11.64+j4.74

Zin\*: Complex conjugate of input impedance Zout\*: Complex conjugate of output impedance

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## RD01MSU1 S-PARAMETER DATA (@Vdd=7.2V, Id=100mA)

| Freq. | S11   |        | S21    |       | S12   |       | S22   |        |
|-------|-------|--------|--------|-------|-------|-------|-------|--------|
| [MHz] | (mag) | (ang)  | (mag)  | (ang) | (mag) | (ang) | (mag) | (ang)  |
| 100   | 0.927 | -77.0  | 19.536 | 132.3 | 0.043 | 41.3  | 0.772 | -63.0  |
| 150   | 0.875 | -101.2 | 15.657 | 116.5 | 0.050 | 26.5  | 0.687 | -83.1  |
| 200   | 0.833 | -117.9 | 12.662 | 105.0 | 0.053 | 16.1  | 0.630 | -97.3  |
| 250   | 0.811 | -129.5 | 10.427 | 96.2  | 0.054 | 8.4   | 0.600 | -107.1 |
| 300   | 0.798 | -138.0 | 8.814  | 89.3  | 0.053 | 2.6   | 0.588 | -114.4 |
| 350   | 0.791 | -144.5 | 7.548  | 83.3  | 0.052 | -2.4  | 0.583 | -120.1 |
| 400   | 0.790 | -149.7 | 6.541  | 78.2  | 0.051 | -6.6  | 0.590 | -124.6 |
| 450   | 0.788 | -154.1 | 5.789  | 73.5  | 0.049 | -9.9  | 0.597 | -128.4 |
| 500   | 0.794 | -158.0 | 5.106  | 69.0  | 0.047 | -13.3 | 0.608 | -131.7 |
| 520   | 0.796 | -159.2 | 4.876  | 67.5  | 0.046 | -14.1 | 0.615 | -133.1 |
| 550   | 0.798 | -161.2 | 4.576  | 65.2  | 0.045 | -15.8 | 0.622 | -134.8 |
| 600   | 0.801 | -164.2 | 4.120  | 61.3  | 0.043 | -18.5 | 0.636 | -137.3 |
| 650   | 0.807 | -167.0 | 3.714  | 58.0  | 0.041 | -21.0 | 0.650 | -140.1 |
| 700   | 0.813 | -169.3 | 3.389  | 54.7  | 0.039 | -22.3 | 0.666 | -142.4 |
| 750   | 0.817 | -171.6 | 3.092  | 51.3  | 0.036 | -24.9 | 0.680 | -144.6 |
| 800   | 0.825 | -174.0 | 2.820  | 48.6  | 0.033 | -25.7 | 0.694 | -146.8 |
| 850   | 0.831 | -176.0 | 2.616  | 46.0  | 0.031 | -26.8 | 0.711 | -148.8 |
| 900   | 0.837 | -178.0 | 2.401  | 42.8  | 0.028 | -27.8 | 0.723 | -150.9 |
| 950   | 0.845 | -179.9 | 2.207  | 40.9  | 0.026 | -27.3 | 0.734 | -152.9 |
| 1000  | 0.851 | 178.2  | 2.076  | 38.4  | 0.023 | -27.0 | 0.749 | -154.5 |
| 1050  | 0.857 | 176.5  | 1.912  | 35.5  | 0.021 | -26.3 | 0.760 | -156.3 |
| 1100  | 0.862 | 174.7  | 1.773  | 34.0  | 0.018 | -23.8 | 0.771 | -158.2 |

### RD01MSU1 S-PARAMETER DATA (@Vdd=12.5V, Id=100mA)

| Freq. | S11   |        | S21    |       | S12   |       | S22   |        |
|-------|-------|--------|--------|-------|-------|-------|-------|--------|
| [MHz] | (mag) | (ang)  | (mag)  | (ang) | (mag) | (ang) | (mag) | (ang)  |
| 100   | 0.945 | -72.3  | 19.517 | 135.2 | 0.039 | 44.5  | 0.742 | -57.4  |
| 150   | 0.896 | -96.7  | 15.937 | 119.5 | 0.046 | 29.2  | 0.665 | -76.6  |
| 200   | 0.856 | -113.9 | 13.050 | 107.7 | 0.049 | 18.5  | 0.612 | -90.6  |
| 250   | 0.833 | -126.2 | 10.830 | 98.6  | 0.050 | 11.2  | 0.581 | -100.4 |
| 300   | 0.819 | -135.1 | 9.194  | 91.6  | 0.050 | 5.0   | 0.568 | -107.8 |
| 350   | 0.810 | -141.9 | 7.890  | 85.3  | 0.049 | -0.3  | 0.565 | -113.8 |
| 400   | 0.806 | -147.7 | 6.868  | 80.1  | 0.047 | -4.2  | 0.571 | -118.5 |
| 450   | 0.804 | -152.2 | 6.084  | 75.3  | 0.046 | -7.7  | 0.580 | -122.3 |
| 500   | 0.808 | -156.4 | 5.382  | 70.7  | 0.044 | -11.0 | 0.591 | -126.1 |
| 520   | 0.809 | -157.8 | 5.139  | 69.1  | 0.044 | -12.4 | 0.596 | -127.5 |
| 550   | 0.812 | -159.9 | 4.831  | 66.7  | 0.042 | -13.7 | 0.605 | -129.4 |
| 600   | 0.813 | -163.0 | 4.356  | 62.7  | 0.040 | -16.2 | 0.618 | -132.2 |
| 650   | 0.819 | -166.0 | 3.931  | 59.3  | 0.038 | -18.7 | 0.633 | -135.1 |
| 700   | 0.824 | -168.6 | 3.597  | 56.0  | 0.036 | -20.8 | 0.649 | -137.6 |
| 750   | 0.827 | -171.0 | 3.283  | 52.4  | 0.034 | -22.3 | 0.664 | -140.1 |
| 800   | 0.834 | -173.3 | 2.991  | 49.8  | 0.031 | -23.7 | 0.678 | -142.5 |
| 850   | 0.841 | -175.5 | 2.779  | 47.1  | 0.029 | -24.6 | 0.695 | -144.5 |
| 900   | 0.845 | -177.4 | 2.554  | 43.8  | 0.026 | -25.9 | 0.708 | -146.7 |
| 950   | 0.852 | -179.4 | 2.350  | 41.9  | 0.024 | -25.4 | 0.720 | -148.9 |
| 1000  | 0.857 | 178.6  | 2.209  | 39.4  | 0.022 | -24.3 | 0.736 | -150.7 |
| 1050  | 0.864 | 176.9  | 2.035  | 36.3  | 0.019 | -23.5 | 0.747 | -152.4 |
| 1100  | 0.868 | 175.0  | 1.889  | 34.8  | 0.017 | -20.1 | 0.759 | -154.6 |

# ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

### Silicon RF Power Semiconductors

# RD01MUS1

RoHS Compliance, Silicon MOSFET Power Transistor 520MHz,1W

#### **ATTENTION:**

- 1.High Temperature; This product might have a heat generation while operation, Please take notice that have a possibility to receive a burn to touch the operating product directly or touch the product until cold after switch off. At the near the product, do not place the combustible material that have possibilities to arise the fire.
- 2.Generation of High Frequency Power; This product generate a high frequency power. Please take notice that do not leakage the unnecessary electric wave and use this products without cause damage for human and property per normal operation.
- 3.Before use; Before use the product, Please design the equipment in consideration of the risk for human and electric wave obstacle for equipment.

#### PRECAUTIONS FOR THE USE OF MITSUBISHI SILICON RF POWER DEVICES:

- 1. The specifications of mention are not guarantee values in this data sheet. Please confirm additional details regarding operation of these products from the formal specification sheet. For copies of the formal specification sheets, please contact one of our sales offices.
- 2. RD series products (RF power transistors) are designed for consumer mobile communication terminals and were not specifically designed for use in other applications. In particular, while these products are highly reliable for their designed purpose, they are not manufactured under a quality assurance testing protocol that is sufficient to guarantee the level of reliability typically deemed necessary for critical communications elements. Examples of critical communications elements would include transmitters for base station applications and fixed station applications that operate with long term continuous transmission and a higher on-off frequency during transmitting, especially for systems that may have a high impact to society.
- 3. RD series products use MOSFET semiconductor technology. They are sensitive to ESD voltage therefore appropriate ESD precautions are required.
- 4. In the case of use in below than recommended frequency, there is possibility to occur that the device is deteriorated or destroyed due to the RF-swing exceed the breakdown voltage.
- 5. In order to maximize reliability of the equipment, it is better to keep the devices temperature low. It is recommended to utilize a sufficient sized heat-sink in conjunction with other cooling methods as needed (fan, etc.) to keep the channel temperature for RD series products lower than 120deg/C(in case of Tchmax=150deg/C),140deg/C(in case of Tchmax=175deg/C) under standard conditions.
- 6. Do not use the device at the exceeded the maximum rating condition. In case of plastic molded devices, the exceeded maximum rating condition may cause blowout, smoldering or catch fire of the molding resin due to extreme short current flow between the drain and the source of the device. These results causes in fire or injury.
- 7. For specific precautions regarding assembly of these products into the equipment, please refer to the supplementary items in the specification sheet.
- 8. Warranty for the product is void if the products protective cap (lid) is removed or if the product is modified in any way from it's original form.
- 9. For additional "Safety first" in your circuit design and notes regarding the materials, please refer the last page of this data sheet.
- 10. Please refer to the additional precautions in the formal specification sheet.

# ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

#### Silicon RF Power Semiconductors

# RD01MUS1

RoHS Compliance, Silicon MOSFET Power Transistor 520MHz,1W

| Neep salety mist in your chount designs | Keep safety first in your circuit de | esigns | ! |
|---|--------------------------------------|--------|---|
|---|--------------------------------------|--------|---|

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